

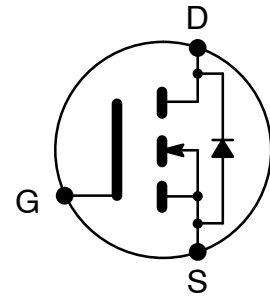


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## NTE2975 MOSFET N-Channel, Enhancement Mode High Speed Switch TO-220 Type Package

**Features:**

- Advanced Process Technology
- Ultra Low On-State Resistance
- Dynamic dv/dt Rating
- +175°C Operating Temperature
- Fast Switching
- Fully Avalanche Rated



**Absolute Maximum Ratings:**

Drain Current, $I_D$	
Continuous ( $V_{GS} = 10V$ )	
$T_C = +25^\circ C$ (Note 1)	53A
$T_C = +100^\circ C$	37A
Pulse (Note 2)	180A
Power Dissipation ( $T_C = +25^\circ C$ ), $P_D$	107W
Derate above $+25^\circ C$	0.71W/ $^\circ C$
Gate-Source Voltage, $V_{GS}$	$\pm 20V$
Avalanche Current (Note 2), $I_{AR}$	28A
Repetitive Avalanche Energy (Note 2), $E_{AR}$	11mJ
Single Pulse Avalanche Energy (Note 3, Note 4), $E_{AS}$	152mJ
Peak Diode Recovery (Note 5), dv/dt	5.0V/ns
Operating Junction Temperature Range, $T_J$	$-55^\circ$ to $+175^\circ C$
Storage Temperature Range, $T_{stg}$	$-55^\circ$ to $+175^\circ C$
Lead Temperature (During Soldering, 1.6mm from case, 10sec max), $T_L$	$+300^\circ C$
Maximum Thermal Resistance, Junction-to-Case, $R_{thJC}$	1.4 $^\circ C/W$
Typical Thermal Resistance, Case-to-Sink (Flat, greased surface), $R_{thCS}$	0.5 $^\circ C/W$
Maximum Thermal Resistance, Junction-to-Ambient, $R_{thJA}$	62 $^\circ C/W$

Note 1. Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 39A.

Note 2. Repetitive rating; pulse width limited by maximum junction temperature.

Note 3. Starting  $T_J = +25^\circ C$ ,  $L = 389\mu H$ ,  $R_G = 25\Omega$ ,  $I_{AS} = 28A$ .

Note 4. This is a calculated value limited to  $T_J = +175^\circ C$ .

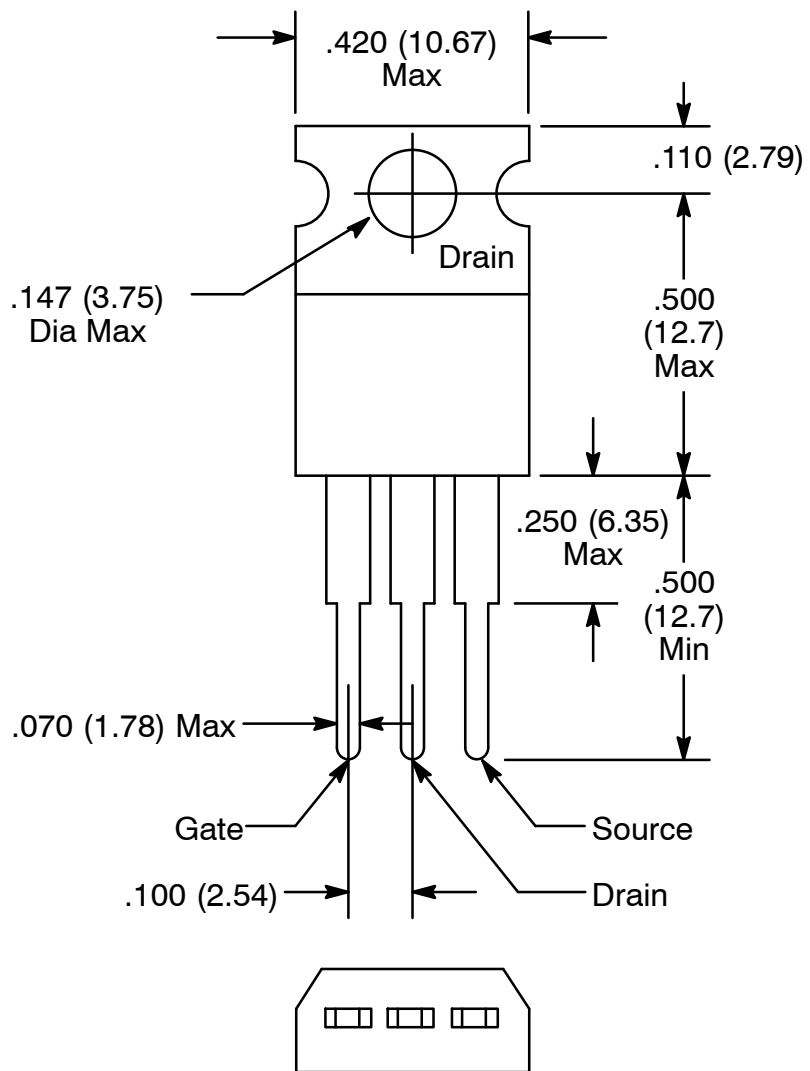
Note 5.  $I_{SD} \leq 28A$ ,  $di/dt \leq 220A/\mu s$ ,  $V_{DD} \leq V_{(BR)DSS}$ ,  $T_J \leq +175^\circ C$

**Electrical Characteristics:** ( $T_J = +25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain–Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	55	–	–	V
Breakdown Voltage Temperature Coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_J}$	Reference to $+25^\circ\text{C}$ , $I_D = 1\text{mA}$	–	0.057	–	$V/^\circ\text{C}$
Static Drain–Source On–Resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 28A$ , Note 6	–	–	16	$\Omega$
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	2.0	–	4.0	V
Forward Transconductance	$g_{fs}$	$V_{DS} = 25V, I_D = 28A$ , Note 6	19	–	–	S
Drain–Source Leakage Current	$I_{DSS}$	$V_{DS} = 55V, V_{GS} = 0$	–	–	25	$\mu A$
		$V_{DS} = 44V, V_{GS} = 0, T_J = +150^\circ\text{C}$	–	–	250	$\mu A$
Gate–Source Forward Leakage Current	$I_{GSS}$	$V_{GS} = 20V$	–	–	100	nA
		$V_{GS} = -20V$	–	–	-100	nA
Total Gate Charge	$Q_G$	$V_{GS} = 10V, I_D = 28A, V_{DS} = 44V$	–	–	72	nC
Gate–Source Charge	$Q_{GS}$		–	–	11	nC
Gate–Drain (“Miller”) Charge	$Q_{GD}$		–	–	26	nC
Turn–On Delay Time	$t_{d(on)}$	$V_{GS} = 10V, V_{DD} = 28V, I_D = 28A, R_G = 12\Omega$	–	14	–	ns
Rise Time	$t_r$		–	76	–	ns
Turn–Off Delay Time	$t_{d(off)}$		–	52	–	ns
Fall Time	$t_f$		–	57	–	ns
Internal Drain Inductance	$L_D$	Between lead, .250 (6mm) from package and center of die contact	–	4.5	–	nH
Internal Source Inductance	$L_S$		–	7.5	–	nH
Input Capacitance	$C_{iss}$	$V_{DS} = 25V, V_{GS} = 0, f = 1\text{MHz}$	–	1696	–	pF
Output Capacitance	$C_{oss}$		–	407	–	pF
Reverse Transfer Capacitance	$C_{rss}$		–	110	–	pF
<b>Source–Drain Ratings and Characteristics</b>						
Continuous Source Current (Body Diode)	$I_S$		–	–	53	A
Pulsed Source Current (Body Diode)	$I_{SM}$	Note 2	–	–	180	A
Diode Forward Voltage	$V_{F(S-D)}$	$T_J = +25^\circ\text{C}, I_S = 28A, V_{GS} = 0$ , Note 6	–	–	1.3	V
Reverse Recovery Time	$t_{rr}$	$T_J = +25^\circ\text{C}, I_F = 28A, di/dt = 100A/\mu s$ , Note 6	–	67	101	ns
Reverse Recovery Charge	$Q_{rr}$		–	208	312	nC
Forward Turn–On Time	$t_{on}$	Intrinsic turn–on time is negligible (turn–on is dominated by $L_S + L_D$ )				

Note 2. Repetitive rating; pulse width limited by maximum junction temperature.

Note 6. Pulse width  $\leq 400\mu s$ , duty cycle  $\leq 2\%$ .



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